International IOR Rectifier

IRFP150NPbF

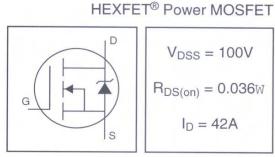
Advanced Process Technology

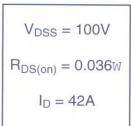
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Lead-Free

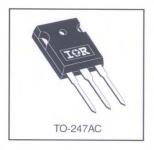
Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The TO-247 package is preferred for commercialindustrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole.







Absolute Maximum Ratings

$I_D @ T_C = 25^{\circ}C$ $I_D @ T_C = 100^{\circ}C$	Continuous Drain Current, V _{GS} @ 10V	42		
0		72		
I const	Continuous Drain Current, V _{GS} @ 10V	30	A	
DM	Pulsed Drain Current ①⑤	140		
P _D @T _C = 25°C	Power Dissipation	160	W	
	Linear Derating Factor	1.1	W/°C	
V _{GS}	Gate-to-Source Voltage	± 20	V	
E _{AS}	Single Pulse Avalanche Energy@S	420	mJ	
I _{AR}	Avalanche Current © S	22	А	
E _{AR}	Repetitive Avalanche Energy①	16	mJ	
dv/dt	Peak Diode Recovery dv/dt 35	ery dv/dt 3 S 5.0		
TJ	Operating Junction and	-55 to + 175		
T _{STG}	Storage Temperature Range		°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting torque, 6-32 or M3 srew	10 lbf•in (1.1N•m)		

Thermal Resistance

	Parameter	Typ.	Max.	Units
R ₀ JC	Junction-to-Case	_	0.95	
R _{0CS}	Case-to-Sink, Flat, Greased Surface	0.24		°C/W
R _{θJA}	Junction-to-Ambient	_	40	

IRFP150NPbF

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	100	-		V	$V_{GS} = 0V$, $I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.11		V/°C	Reference to 25°C, ID = 1mA®
R _{DS(on)}	Static Drain-to-Source On-Resistance	-	_	0.036	Ω	V _{GS} = 10V, I _D = 23A ④
V _{GS(th)}	Gate Threshold Voltage	2.0	_	4.0	٧	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
9ts	Forward Transconductance	14	_		S	V _{DS} = 25V, I _D = 22A ^⑤
	D. I. I. G Looks on Company	-		25	μА	$V_{DS} = 100V, V_{GS} = 0V$
DSS	Drain-to-Source Leakage Current	_		250		V _{DS} = 80V, V _{GS} = 0V, T _J = 150°C
2/	Gate-to-Source Forward Leakage	_		100	A	$V_{GS} = 20V$
I _{GSS}	Gate-to-Source Reverse Leakage	_	_	-100	nA	$V_{GS} = -20V$
Qq	Total Gate Charge	_	-	110		I _D = 22A
Qgs	Gate-to-Source Charge	_		15	nC	$V_{DS} = 80V$
Q _{ad}	Gate-to-Drain ("Miller") Charge	_	-	58		V _{GS} = 10V, See Fig. 6 and 13 @ 5
t _{d(on)}	Turn-On Delay Time		11	-		$V_{DD} = 50V$
tr	Rise Time	_	56	-		I _D = 22A
t _{d(off)}	Turn-Off Delay Time	_	45	_	ns	R _G = 3.6W
t _f	Fall Time	-	40	_		R _D = 2.9W, See Fig. 10 4 9
L _D	Internal Drain Inductance	_	5.0	-	-11	Between lead, 6mm (0.25in.)
L _S	Internal Source Inductance	_	13		nH	from package and center of die contact
Ciss	Input Capacitance		1900			V _{GS} = 0V
Coss	Output Capacitance	_	450	-	pF	V _{DS} = 25V
Crss	Reverse Transfer Capacitance		230	_		f = 1.0 MHz, See Fig. 5©

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
ls	Continuous Source Current (Body Diode)	_	_	42	A	MOSFET symbol showing the
I _{SM}	Pulsed Source Current (Body Diode) ①⑤		_	140		integral reverse p-n junction diode.
V _{SD}	Diode Forward Voltage	_	_	1.3	V	$T_J = 25$ °C, $I_S = 23A$, $V_{GS} = 0V$ ④
t _{rr}	Reverse Recovery Time		180	270	ns	$T_J = 25^{\circ}C, I_F = 22A$
Qrr	Reverse RecoveryCharge		1.2	1.8	μC	di/dt = 100A/µs ④ ⑤
ton	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L _S +L _D				

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- $\begin{tabular}{ll} \hline @ Starting $T_J=25^\circ$C, $L=1.7mH$\\ $R_G=25$\%, $I_{AS}=22$A. (See Figure 12) \\ \hline \end{tabular}$
- $\label{eq:loss_def} \begin{tabular}{ll} \begin{tabular}{ll} $I_{SD} \leq 22A, \; di/dt \leq 180A/\mu s, \; V_{DD} \leq V_{(BR)DSS}, \\ $T_{J} \leq 175^{\circ}C$ \end{tabular}$
- 4 Pulse width \leq 300 μ s; duty cycle \leq 2%.
- (5) Uses IRF1310N data and test conditions

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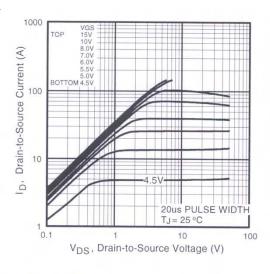


Fig 1. Typical Output Characteristics

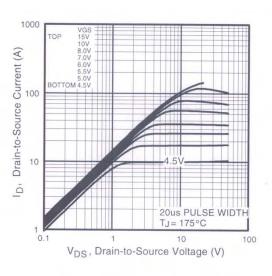


Fig 2. Typical Output Characteristics

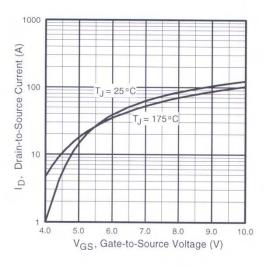


Fig 3. Typical Transfer Characteristics

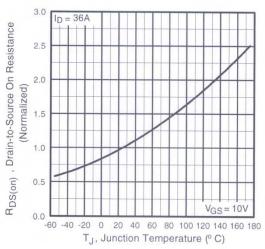


Fig 4. Normalized On-Resistance Vs. Temperature

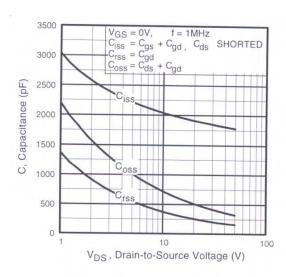


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

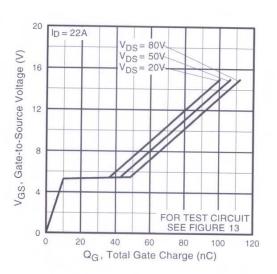


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

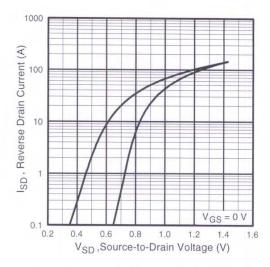


Fig 7. Typical Source-Drain Diode Forward Voltage

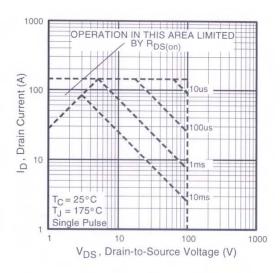


Fig 8. Maximum Safe Operating Area

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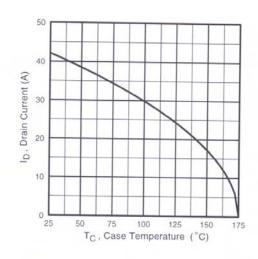


Fig 9. Maximum Drain Current Vs. Case Temperature

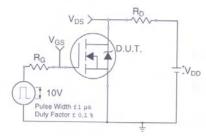


Fig 10a. Switching Time Test Circuit

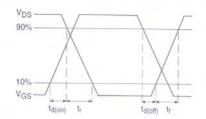


Fig 10b. Switching Time Waveforms

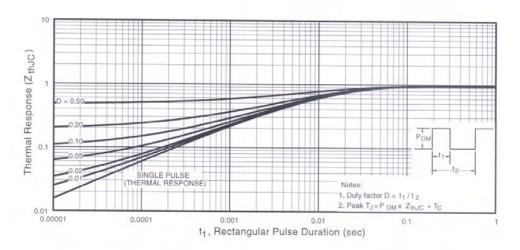


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

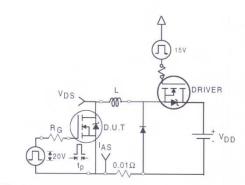


Fig 12a. Unclamped Inductive Test Circuit

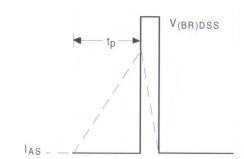


Fig 12b. Unclamped Inductive Waveforms

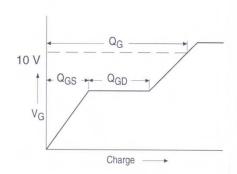


Fig 13a. Basic Gate Charge Waveform

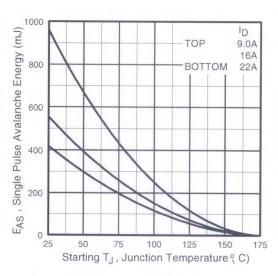


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

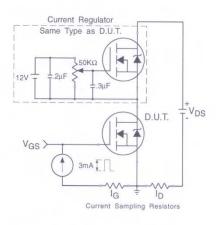
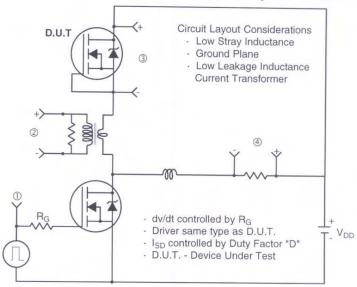


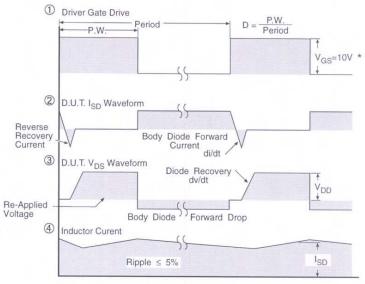
Fig 13b. Gate Charge Test Circuit

IRFP150NPbF

7

Peak Diode Recovery dv/dt Test Circuit



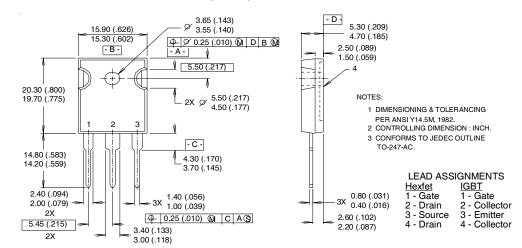


* V_{GS} = 5V for Logic Level Devices

Fig 14. For N-Channel HEXFETS

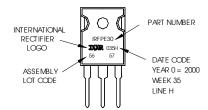
TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



TO-247AC Part Marking Information





Data and specifications subject to change without notice.



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